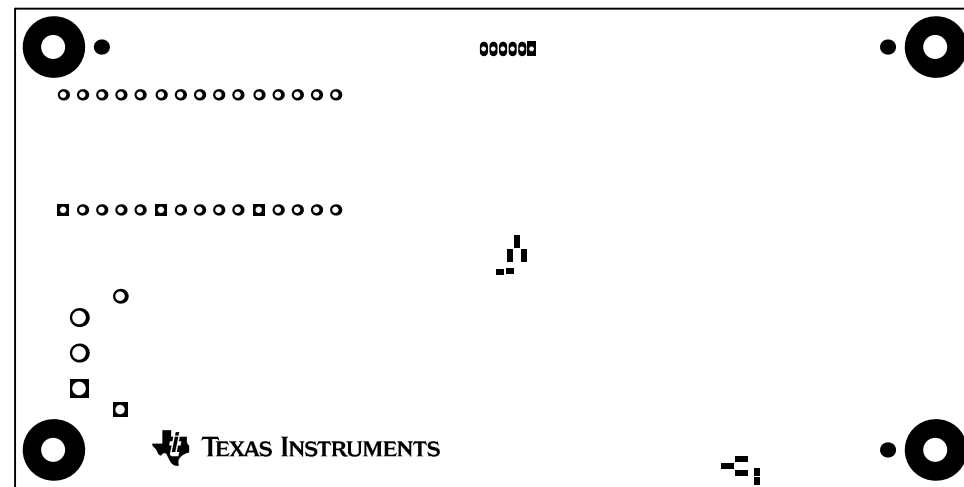
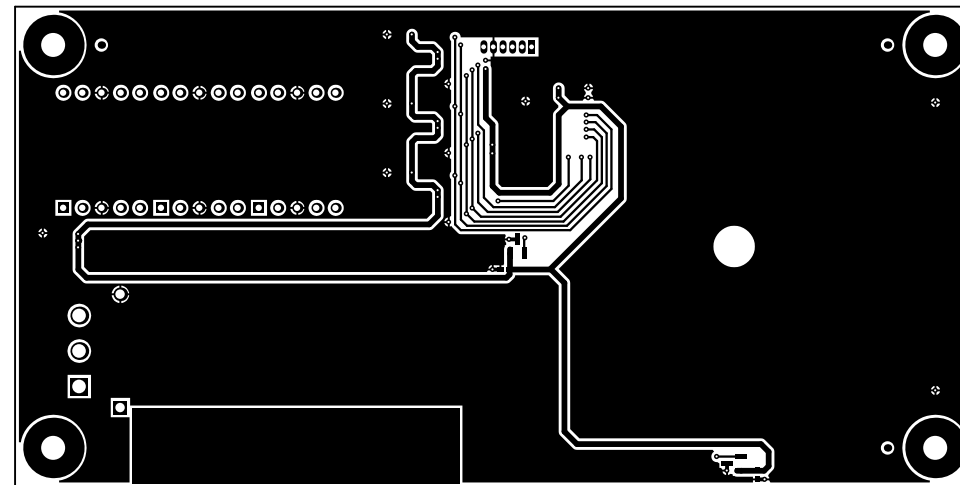


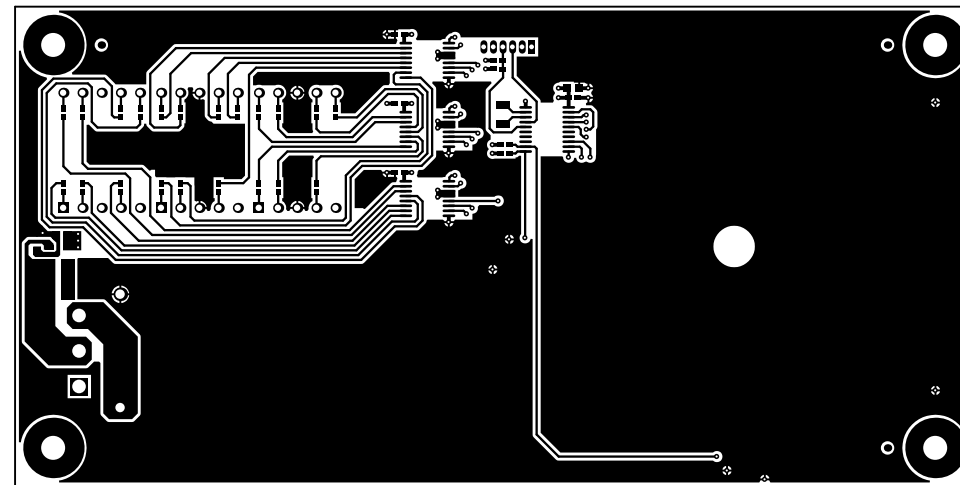
|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00480              | REV: E1           | SUN REV: Not In VersionControl |
| LAYER NAME = Top Overlay         |                                  |                   |                                |
| PLOT NAME = Top Overlay          | GENERATED : 2/18/2015 2:27:10 PM | TEXAS INSTRUMENTS |                                |



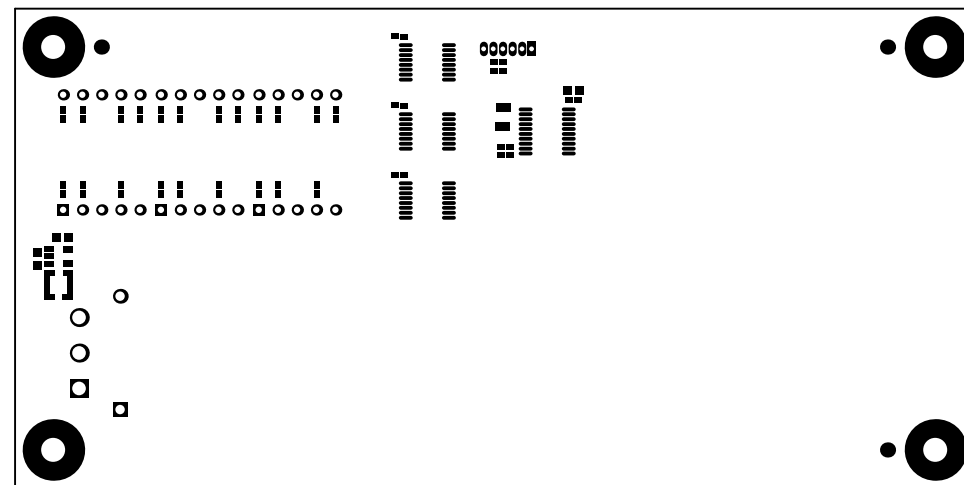
|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00480              | REV: E1           | SUN REV: Not In VersionControl |
| LAYER NAME = Top Solder          |                                  |                   |                                |
| PLOT NAME = Top Solder Mask      | GENERATED : 2/18/2015 2:27:11 PM | TEXAS INSTRUMENTS |                                |



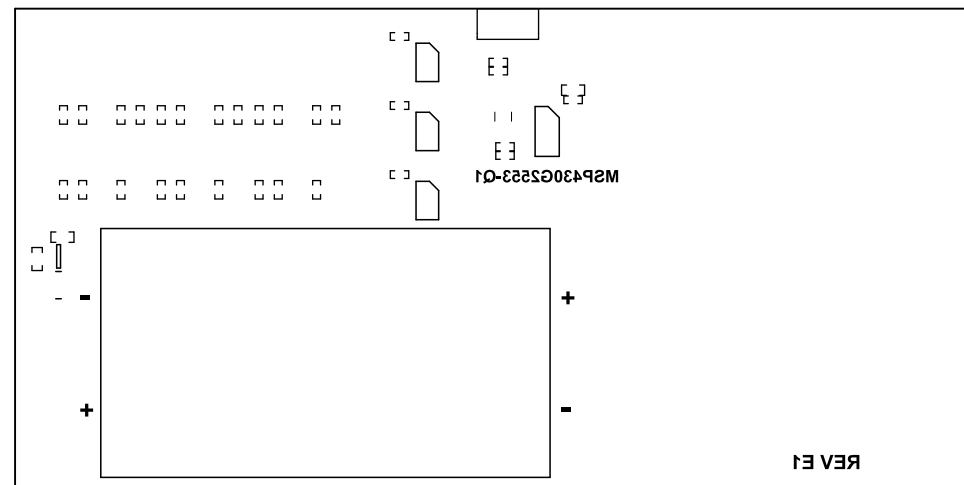
|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00480              | REV: E1           | SUN REV: Not In VersionControl |
| LAYER NAME = Layer 1 - Top Layer |                                  |                   |                                |
| PLOT NAME = Top Layer            | GENERATED : 2/18/2015 2:27:12 PM | TEXAS INSTRUMENTS |                                |



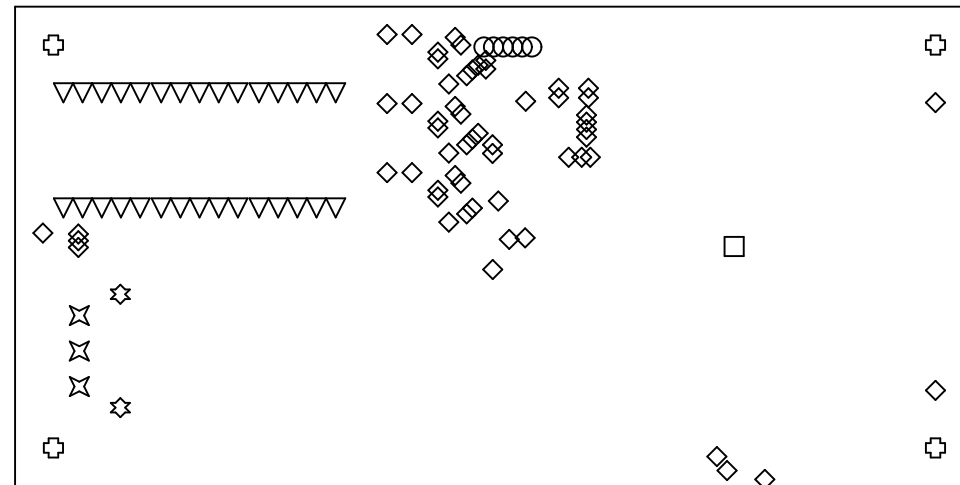
|                                     |                                  |                   |                                |
|-------------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE    | BOARD #: TIDA-00480              | REV: E1           | SUN REV: Not In VersionControl |
| LAYER NAME = Layer 2 - Bottom Layer |                                  |                   |                                |
| PLOT NAME = Bottom Layer            | GENERATED : 2/18/2015 2:27:12 PM | TEXAS INSTRUMENTS |                                |



|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00480              | REV: E1           | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Solder       |                                  |                   |                                |
| PLOT NAME = Bottom Solder Mask   | GENERATED : 2/18/2015 2:27:13 PM | TEXAS INSTRUMENTS |                                |



|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00480              | REV: E1           | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Overlay      |                                  |                   |                                |
| PLOT NAME = Bottom Overlay       | GENERATED : 2/18/2015 2:27:14 PM | TEXAS INSTRUMENTS |                                |



| Symbol | Quantity  | Finished Hole Size  | Plated | Hole Type |
|--------|-----------|---------------------|--------|-----------|
| □      | 1         | 185.00mil (4.699mm) | NPTH   | Round     |
| ◇      | 58        | 12.00mil (0.305mm)  | PTH    | Round     |
| ○      | 6         | 26.00mil (0.660mm)  | PTH    | Round     |
| ▽      | 30        | 33.46mil (0.850mm)  | PTH    | Round     |
| ☆      | 2         | 50.00mil (1.270mm)  | PTH    | Round     |
| ✱      | 3         | 72.83mil (1.850mm)  | PTH    | Round     |
| ⊕      | 4         | 125.98mil (3.200mm) | PTH    | Round     |
|        | 104 Total |                     |        |           |

|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00480              | REV: E1           | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing       |                                  |                   |                                |
| PLOT NAME = Drill Drawing        | GENERATED : 2/18/2015 2:27:15 PM | TEXAS INSTRUMENTS |                                |



|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00480              | REV: E1           | SUN REV: Not In VersionControl |
| LAYER NAME = M2 Board Dimensions |                                  |                   |                                |
| PLOT NAME = Board Dimensions     | GENERATED : 2/18/2015 2:27:15 PM | TEXAS INSTRUMENTS |                                |



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